TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

### SSM3J09FU

# Management Switch High Speed Switching Applications

· Small package

• Low on resistance:  $R_{on} = 2.7 \Omega \text{ (max) (@V}_{GS} = -10 \text{ V)}$ 

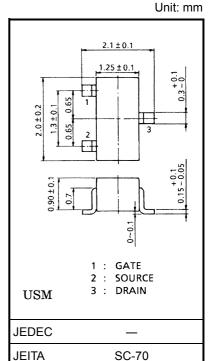
:  $R_{on} = 4.2 \Omega \text{ (max) } (@V_{GS} = -4 \text{ V})$ 

#### **Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DS}$	-30	V	
Gate-Source voltage		$V_{GSS}$	±20	V	
Drain current	DC	I <sub>D</sub>	-200	mA	
	Pulse	I <sub>DP</sub>	-400		
Drain power dissipation (Ta = 25°C)		P <sub>D</sub> (Note1)	150	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		T <sub>stg</sub>	<b>−55~150</b>	°C	

Note 1: Mounted on FR4 board

(25.4 mm  $\times$  25.4 mm  $\times$  1.6 t, Cu Pad: 0.6 mm<sup>2</sup>  $\times$  3) Figure 1.



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Weight: 0.006 g (typ.)

**TOSHIBA** 

#### Marking

# D K

## Equivalent Circuit (top view)

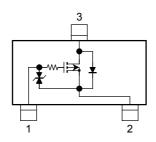
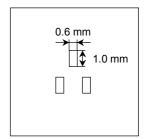


Figure 1: 25.4 mm  $\times$  25.4 mm  $\times$  1.6 t, Cu Pad: 0.6 mm<sup>2</sup>  $\times$  3



#### **Handling Precaution**

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

#### **Electrical Characteristics (Ta = 25°C)**

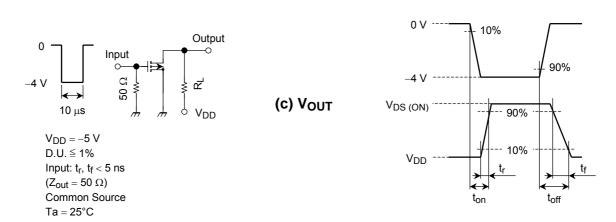
Chara	Characteristics Symbol Test Condition		Min	Тур.	Max	Unit	
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	_	_	±1	μΑ
Drain-Source brea	n-Source breakdown voltage $V_{(BR)DSS}$ $I_D = -1$ mA, $V_{GS} = 0$		-30	_	_	V	
Drain cut-off curre	ent	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	_	_	-1	μА
Gate threshold vo	Itage	V <sub>th</sub>	$V_{DS} = -5 \text{ V}, I_D = -0.1 \text{ mA}$	-1.1	_	-1.8	V
Forward transfer a	admittance	Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_D = -100 \text{ mA}$ (Note2)	115	_	_	mS
Drain-Source ON resistance		R <sub>DS (ON)</sub>	$I_D = -100 \text{ mA}, V_{GS} = -10 \text{ V}$ (Note2)	_	2.1	2.7	Ω
			$I_D = -100 \text{ mA}, V_{GS} = -4 \text{ V}$ (Note2)	_	3.3	4.2	
			$I_D = -100 \text{ mA}, V_{GS} = -3.3 \text{ V}$ (Note2)	_	4.0	6.0	
Input capacitance		C <sub>iss</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	22	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	5	_	pF
Output capacitance		C <sub>oss</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	14	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -5 \text{ V}, I_D = -100 \text{ mA},$	_	85	_	ns
	Turn-off time	t <sub>off</sub>	V <sub>GS</sub> = 0~-4 V	_	85	_	ns

Note 2: Pulse test

#### **Switching Time Test Circuit**







#### **Precaution**

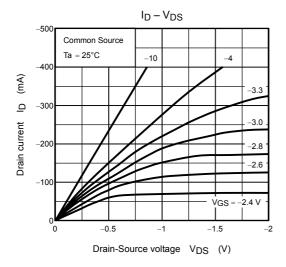
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  =  $-100~\mu A$  for this product. For normal switching operation,  $V_{GS}$  (on) requires higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires lower voltage than  $V_{th}$ .

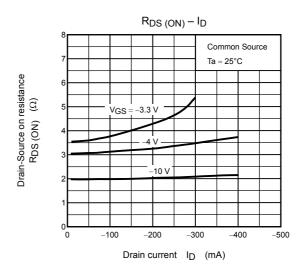
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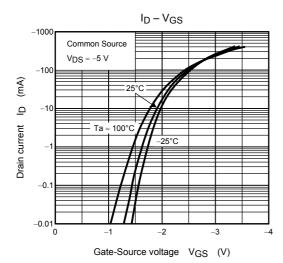
(relationship can be established as follows:  $V_{GS}$  (off) <  $V_{th}$  <  $V_{GS}$  (on) )

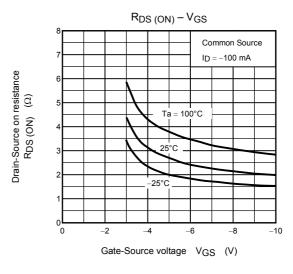
Please take this into consideration for using the device.

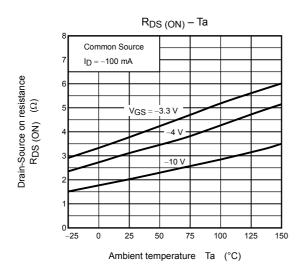
 $V_{\rm GS}$  recommended voltage of –4.0 V or higher to turn on this product.

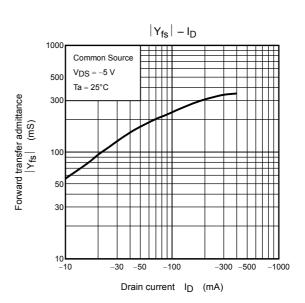




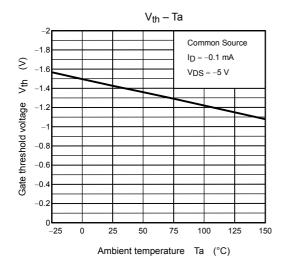


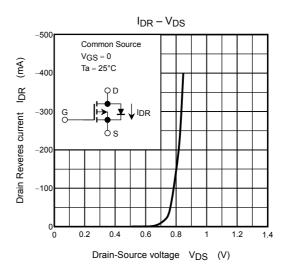


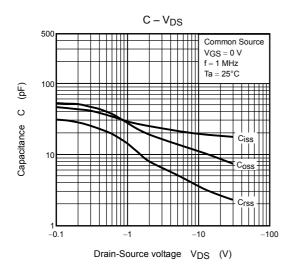


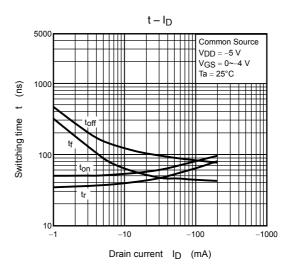


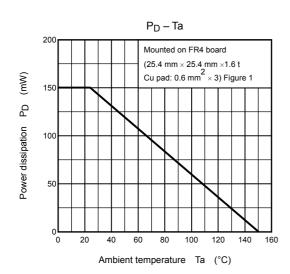
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